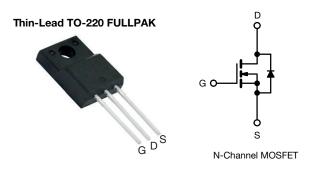
SiHA690N60E

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Vishay Siliconix

E Series Power MOSFET



PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.60		
Q _g max. (nC)	12			
Q _{gs} (nC)	3			
Q _{gd} (nC)	3			
Configuration	Single			

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (C_{o(er)})
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	Thin-Lead TO-220 FULLPAK
Lead (Pb)-free and halogen-free	SiHA690N60E-GE3

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$, unless otherwise noted)							
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-source voltage			V _{DS}	600	V		
Gate-source voltage			V _{GS}	± 30	V		
Continuous drain current (T _J = 150 °C) $^{\circ}$ C	V _{GS} at 10 V	$T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$	1	4.3			
	VGS at 10 V	T _C = 100 °C	Ι _D	2.7	A		
Pulsed drain current ^a			I _{DM}	11			
Linear derating factor				0.23	W/°C		
Single pulse avalanche energy ^b			E _{AS}	9	mJ		
Maximum power dissipation			PD	29	W		
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C		
Drain-source voltage slope		T _J = 125 °C	du/dt	70	V/ns		
Reverse diode dv/dt ^d			dv/dt	17	v/ns		
Soldering recommendations (peak temperature) ^c		For 10 s		260	°C		
Mounting torque, M3 screw			0.6	Nm			

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 0.8 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D, \, di/dt$ = 100 A/µs, starting T_J = 25 $^\circ C$

e. Limited by maximum junction temperature

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THERMAL RESISTANCE RAT	INGS								
PARAMETER	SYMBOL	TYP.		MAX.		UNIT			
Maximum junction-to-ambient	R _{thJA}	- 65			°C M				
Maximum junction-to-case (drain)	R _{thJC}	- 4.3				°C/W			
SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)									
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT	
Static									
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	250 μΑ	600	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	I _D = 1 mA	-	0.73	-	V/°C	
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	V_{GS} , $I_D = 2$	250 μΑ	3.0	-	5.0	V	
Gate-source leakage	lasa	$V_{GS} = \pm 20 V$			-	-	± 100	nA	
Gale-Source leakage	I _{GSS}	١	/ _{GS} = ± 30	V	-	-	± 1	μA	
Zere gete veltage drein ourrent		$V_{DS} = 600 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			-	-	1	μA	
Zero gate voltage drain current	IDSS	V _{DS} = 480 V, V _{GS} = 0 V, T _J = 125 °C			-	-	10		
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	١ _c	₀ = 2.0 A	-	0.60	0.70	Ω	
Forward transconductance ^a	9 _{fs}	V _{DS} =	= 20 V, I _D =	= 2.0 A	-	1.2	-	S	
Dynamic									
Input capacitance	C _{iss}		V _{GS} = 0 V,		-	347	-		
Output capacitance	C _{oss}	$V_{DS} = 100 V,$ f = 1 MHz		-	24	-	pF		
Reverse transfer capacitance	C _{rss}			-	4	-			
Effective output capacitance, energy related ^a	C _{o(er)}	V_{DS} = 0 V to 480 V, V_{GS} = 0 V		-	17	-			
Effective output capacitance, time related ^b	C _{o(tr)}			-	86	-			
Total gate charge	Qg				-	8	12		
Gate-source charge	Q _{gs}	V _{GS} = 10 V	V _{GS} = 10 V I _D = 2.0 A, V _{DS} =		-	3	-	nC	
Gate-drain charge	Q _{gd}				-	3	-		
Turn-on delay time	t _{d(on)}				-	12	24		
Rise time	t _r	V _{DD} =	V_{DD} = 480 V, I_D = 2.0 A, V_{GS} = 10 V, R_g = 9.1 Ω		-	9	18	ns	
Turn-off delay time	t _{d(off)}				-	19	38		
Fall time	t _f]			-	22	44		
Gate input resistance	R _g	f = 1 MHz, open drain		1.1	2.3	4.6	Ω		
Drain-Source Body Diode Characterist									
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	6.4	A		
Pulsed diode forward current	I _{SM}			-	-	11			
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 2.0 A, V _{GS} = 0 V		-	-	1.2	V		
Reverse recovery time	t _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 2.0 \text{ A},$ di/dt = 100 A/µs, V _R = 25 V		-	146	292	ns		
Reverse recovery charge	Q _{rr}			-	1.0	2.0	μC		
Reverse recovery current	I _{RRM}			-	13	-	A		
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Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

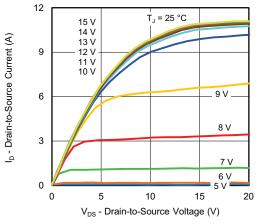


Fig. 1 - Typical Output Characteristics

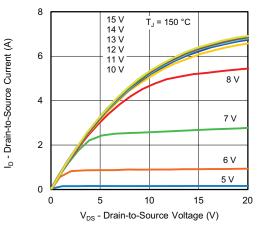


Fig. 2 - Typical Output Characteristics

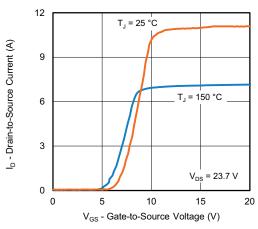


Fig. 3 - Typical Transfer Characteristics

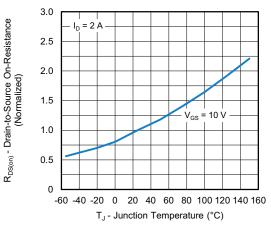


Fig. 4 - Normalized On-Resistance vs. Temperature

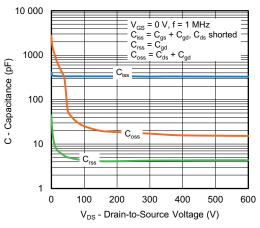


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

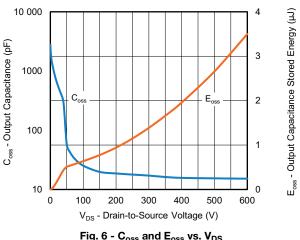


Fig. 6 - Coss and Eoss vs. VDS

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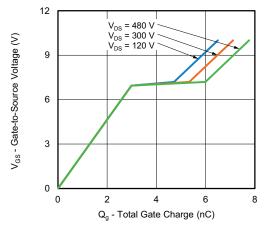


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

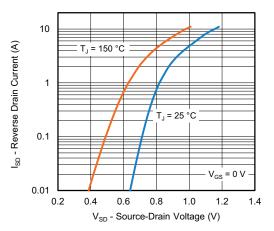


Fig. 8 - Typical Source-Drain Diode Forward Voltage

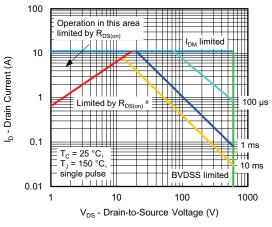


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

4

675 650 625 600 0 20 40 60 80 100 120 140 160 -60 -40 -20 T_J - Junction Temperature (°C) Fig. 11 - Temperature vs. Drain-to-Source Voltage

V_{DS} - Drain-to-Source Breakdown Voltage (V)

775

750

725

700

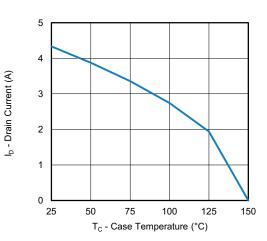
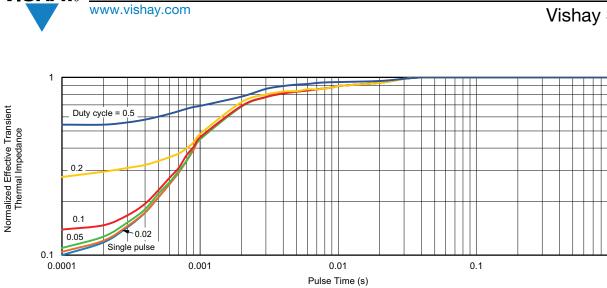
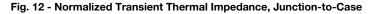


Fig. 10 - Maximum Drain Current vs. Case Temperature

I_D = 250 μA





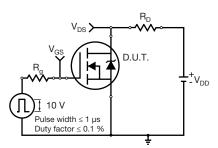


Fig. 13 - Switching Time Test Circuit

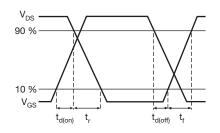


Fig. 14 - Switching Time Waveforms

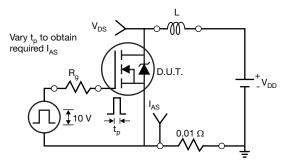


Fig. 15 - Unclamped Inductive Test Circuit

Fig. 16 - Unclamped Inductive Waveforms

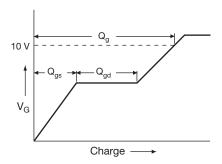


Fig. 17 - Basic Gate Charge Waveform

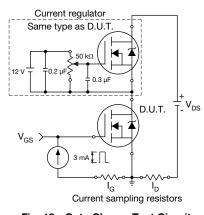


Fig. 18 - Gate Charge Test Circuit

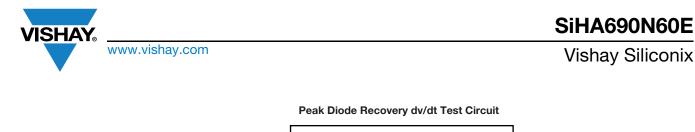
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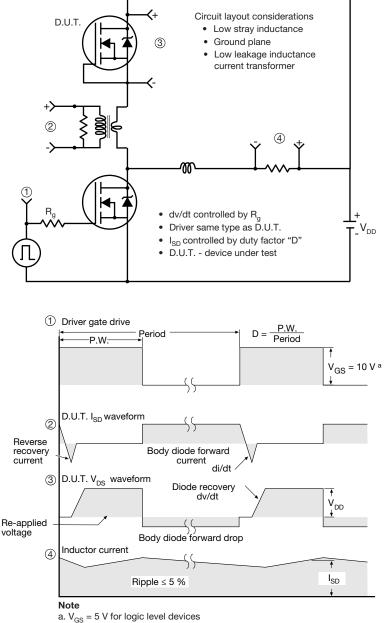


Fig. 19 - For N-Channel

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